



AF 1241 0400

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 09/772,457

Filed: January 30, 2001

For: METHOD OF PLATING
FOR FILLING VIA HOLES

Inventor: Kenji Nakamura, et al.

Atty Doc. No.: 21-01

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Post Office as first class mail postage prepaid in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on March 28, 2001

John F. McNulty
John F. McNulty, Reg. No. 23,028
Dated March 28, 2001

COVER LETTER WITH CERTIFICATE OF MAILING

Assistant Commissioner
for Patents
Washington, D.C. 20231

Sir:

Enclosed and attached hereto are the following documents:

- (1) Information Disclosure Statement with attachments;
- (2) PTO form 1449;
- (3) Cover Letter with Certificate of Mailing (duplicate), and
- (4) Paul & Paul postcard to be returned by PTO.

THE COMMISSIONER IS HEREBY AUTHORIZED TO CHARGE ANY ADDITIONAL FEES ASSOCIATED WITH THIS COMMUNICATION, OR CREDIT ANY OVERPAYMENT, TO PAUL & PAUL DEPOSIT ACCOUNT NO. 16-0750, ORDER NO. _____.

Respectfully submitted,

John F. McNulty
John F. McNulty
Reg. No. 23,028

Paul & Paul
2900 Two Thousand Market St.
Philadelphia, PA 19103
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TC 1700 MAIL ROOM



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INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

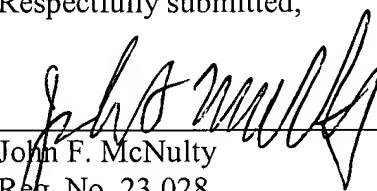
In the interest of full disclosure, the following items are herewith identified in Form PTO-1449 and a copy of the same is hereby provided, for the convenience of the U.S. Patent and Trademark Office.

This Information Disclosure Statement is being filed before the mailing date of the first official action.

FOREIGN PATENTS

(AL) Japanese Patent No. 2000-219994, dated August 8, 2000. For relevance see translation of related portions of Japanese unexamined patent publication (KOKAI) No. 2000-219994.

Respectfully submitted,



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